DS07-10204-1E

### Resonator

# Piezoelectric Resonator (4 to 16 MHz)

# FAR Family (C4 series P/Q type) For Motor Application

#### **■ DESCRIPTION**

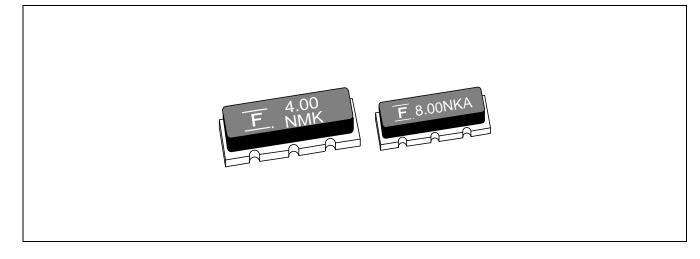
Fujitsu resonators C4 series (P/Q type) feature single crystals with a high electro-mechanical coefficient (LiNbO<sub>3</sub>: lithium niobate), the result is very compact packaging.

C4 series (P/Q type) with built-in capacitors for exclusive use in microcomputer clocks, and this series is chip type device for surface-mount and suitable for motor application due to its high reliability package.

#### **■ FEATURES**

- Wide frequency range in 4 to 16 MHz
- Suitable for microcomputer clock
- PCT (121 °C, 2 atms, 96 hours) is guaranteed for Motor application.
- Emboss-typed pack for automatic mounting
- · Superior shock and vibration resistance, preventing damage during automatic mounting

#### ■ PACKAGE



### ■ STANDARD CHARACTERISTICS

Series Parameter	C4 series (P/Q type)	Remarks
Material	Lithium Niobate (LiNbO <sub>3</sub> )	
Frequency	4 to 16 MHz	
Standard frequency	See "■ Standard Frequency."	
Initial frequency deviation	±0.5% (M)	The ±0.3% (K) version can also be produced.
Temperature characteristic (–40°C to +105°C)	± 0.9 % (M)	Reference temperature: +25°C
Capacity of built-in capacitor	20±8 pF (standard)	10±4 pF, 30±8 pF are also available. Capacity is specified by Fujitsu, considering matching data with applied IC (mainly microcomputer).
Aging stability	Within ±0.1%	For ten years at room temperature
PCT	96 hours guaranteed	Unsturated PCT: 121°C 2 atomospheric pressures
Operating temperature	-40°C to +105°C	
Storage temperature	−55°C to +105°C	
Standard measuring circuit	<ul> <li>Resonant frequency</li> <li>1 MΩ</li> <li>FAR</li> <li>Serial resonant resistance</li> </ul>	4 MHz to 10 MHz IC: MB84069B×2 10 MHz to 16.0 MHz IC: MC74HC04×2  • Vcc: 5 V DC • R: Resonator • C1, C2: Loading capacitors (built-in)  R: Resonator Measuring instrument: Network analyzer

#### **■ STANDARD FREQUENCY**

Standard frequency (kHz)	Package size	Resonant resistance
4,000	Р	150 Ω max. (Symbol: 01)
8,000 10,000 12,000 16,000	Q	75 Ω max. (Symbol: 02)

**Notes:** • Fujitsu can also develop applicable device in addition to standard devices if it's oscillation frequency is from 4 to 16 MHz.

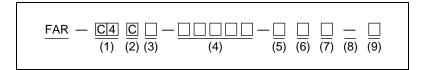
- Resonant resistance of the part other than standard, Fujitsu should specify its resonant resistance according to applied frequency. (See "• Frequency and standard resonant resistance.")
- Frequency and standard resonant resistance

Frequency	Standard resonant resistance
4.00 to 5.99 MHz	150 Ω max. (Symbol: 1)
6.00 to 16.00 MHz	75 Ω max. (Symbol: 2)

#### **■ NOTES ON USE**

- · Handle carefully
- Solder under the following conditions.
  - 5 seconds max. at 230°C (PCB)
  - Recommended preheating is 150°C for one minute in order not to apply extreme heat to the resonator.
- Avoid extreme fluctuations in temperature.
- There is no specific direction in resonator mounting.
- Oscillation data should be examined when used in oscillation circuit with microcomputer or other ICs.
- This is for reflow solder, not for flow solder.

### **■ PART NUMBERING SYSTEM**



### (1) Series

Series	Single crystal	Capacitator
C4	LiNbO <sub>3</sub>	With built-in capacitator

### (2) Package Type

Specification	Туре
С	CHIP

#### (3) Package Size

Specification	Size
Р	Large (4.0 to 5.9 MHz)
Q	Small (6.0 to 16.0 MHz)

### (4) Frequency

(Example) Unit: kHz (Specify in five digits.)

Frequency	Specification
8.000 MHz	08000

See "■ Standard Frequency".

### (5) Initial Frequency Deviation

Specification	Deviation
К	±0.3%
M	±0.5%

#### (6) Built-in Capacitor

Specification	Capacitance
0	20±8 pF
1	10±4 pF
2	30±8 pF

### (7) Resonant Resistance

Specification	Resonant resistance
1	150 Ω
2	75 Ω

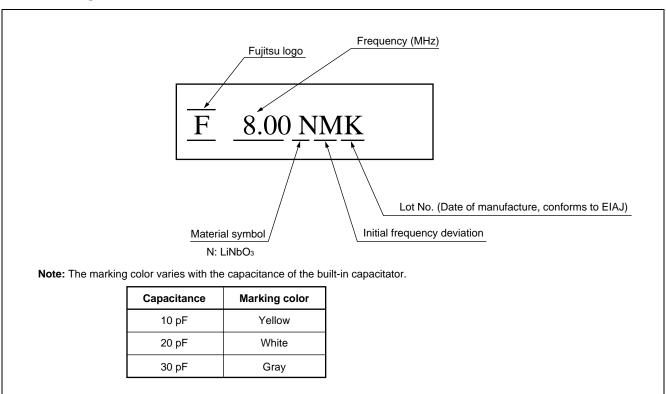
### (8) User-specific Special Symbols

Specification	Description
Name	No specifications, no taping specification
_	No specifications, with taping specification
A to Z	Serial number for custom design

### (9) Taping Specification

Specification	Description
R	16 mm wide emboss tape (3,000 pcs)

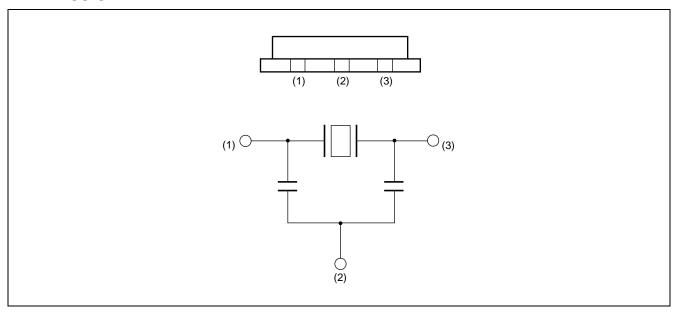
#### **■ MARKING**



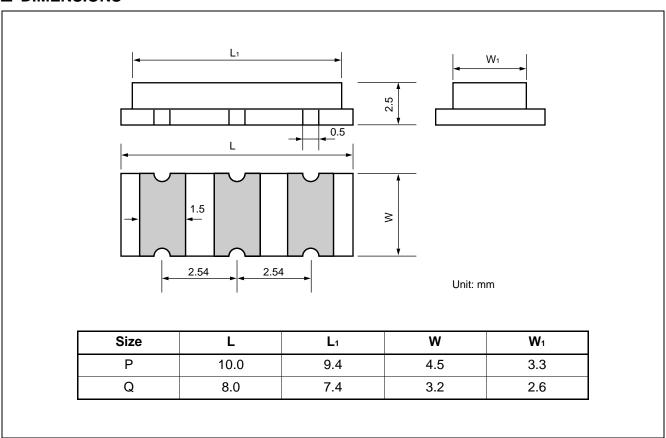
Data code (EIAJ standard) is specified as follows in four-year cycle.

Year	Month	Symbol	Year	Month	Symbol	Year	Month	Symbol	Year	Month	Symbol
1997 2001	1	Α	1998 2002	1	N	1999 2003	1	а	2000 2004	1	n
	2	В		2	Р		2	b		2	p
	3	С		3	Q		3	ē		3	8
	4	D		4	R		4	d		4	r
	5	F		5	S		5	е		5	٥
	6	G		6	Т		6	f		6	t
	7	Н		7	U		7	9		7	u
	8	I		8	V		8	h		8	u
	9	J		9	W		9	j		9	w
	10	К		10	Х		10	k		10	x
	11	L		11	Y		11	e		11	y
	12	М		12	Z		12	m		12	3

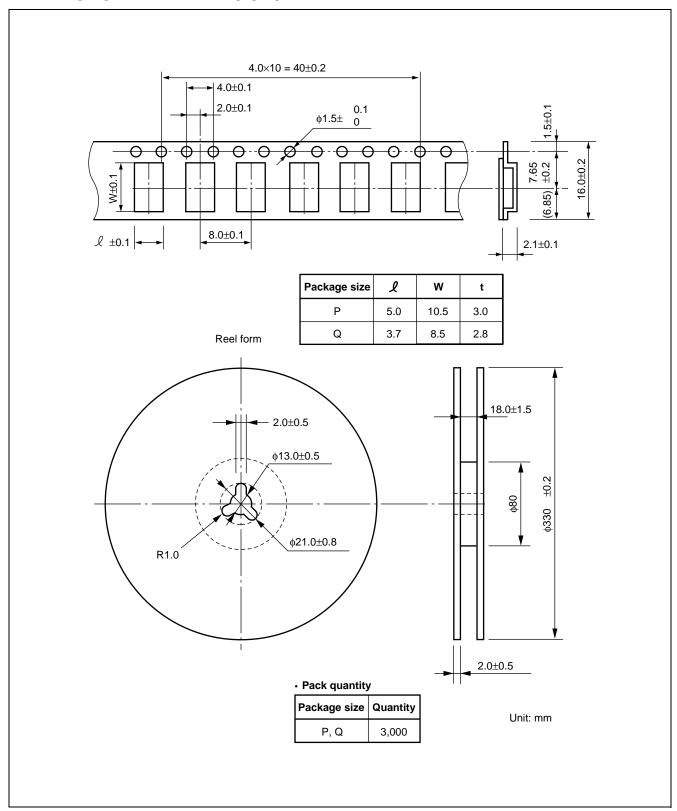
### **■ PIN ASSIGNMENT**



### **■** DIMENSIONS



### **■ TAPING FORM AND DIMENSIONS**



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